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SMB1N-970D

- **Infrared High Power LED**
- **970 nm, 780 mW**
- **AlGaAs chip, 1000 x 1000 µm**
- **PA9T SMD package**
- **Beam Angle: ± 65°**

Description

SMB1N-970D is a surface mount AlGaAs based high power infrared LED, with a typical peak wavelength of 970 nm and optical output power of 780 mW @ 1 A. It comes in polyamide resin SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and silicone resin mold. Additional variants with different beam angles are available on request.

Maximum Ratings*

Parameter	Symbol	Values Min.	Max.	Unit
Power Dissipation	P_D		2500	mW
Forward Current	I_F		1000	mA
Pulse Forward Current **	I_{FP}		3000	mA
Reverse Voltage	U_R		5	V
Thermal Resistance	R_{THJA}		10	K/W
Junction Temperature	T_J		120	°C
Operating Temperature	T_{CASE}	- 40	+ 100	°C
Storage Temperature	T_{STG}	- 40	+ 100	°C
Lead Solder Temperature (t_{max}. 5s)	T_{SLD}		+ 250	°C

*Operating close to or exceeding these parameters may damage the device
** duty cycle = 1 %, pulse width = 10 µs

Electro-Optical Characteristics (T_{CASE} = 25°C)

| Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I_F=1 A	960		980	nm
Half Width	λ_Δ	I_F=1 A		60		nm
Forward Voltage	U_F	I_F=1 A		1.8	2.5	V
	U_{FP}	I_{FP}=3 A*		2.7		
Total Radiated Power	P_O	I_F=1 A		780		mW
		I_{FP}=3 A*		2000		
Radiant Intensity	I_E	I_F=1 A		260		mW/sr
		I_{FP}=3 A*		660		
Beam Angle	$2\theta_{1/2}$	I_F=100 mA		130		deg.
Rise Time	t_r	I_F=1 A		35		ns
Fall Time	t_f	I_F=1 A		30		ns

* duty cycle = 1 %, pulse width = 10 µs

Typical Performance Curves

Forward Current vs. Forward Voltage
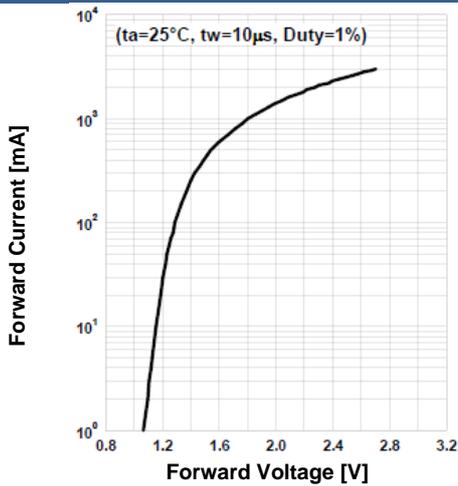
Relative Radiant Intensity vs. Forward Current
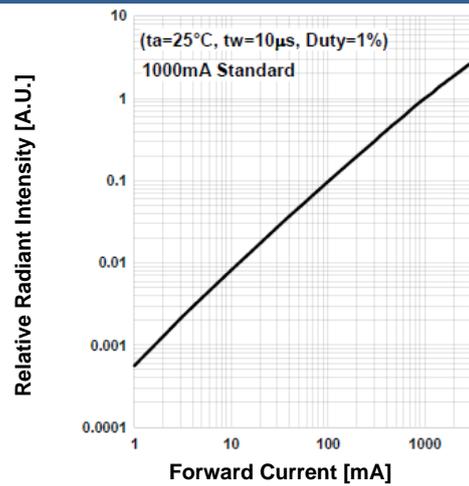
Forward Current vs. Pulse Duration
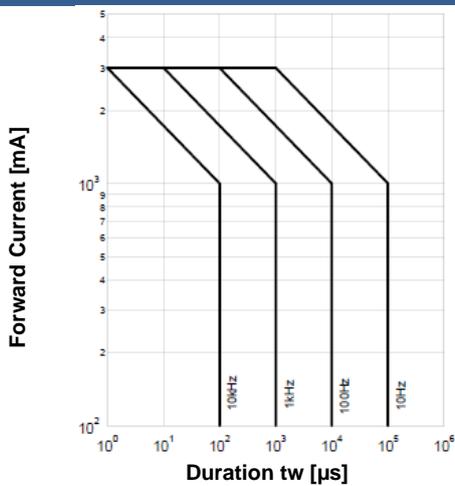
Allowed Forward Current vs. Amb. Temperature
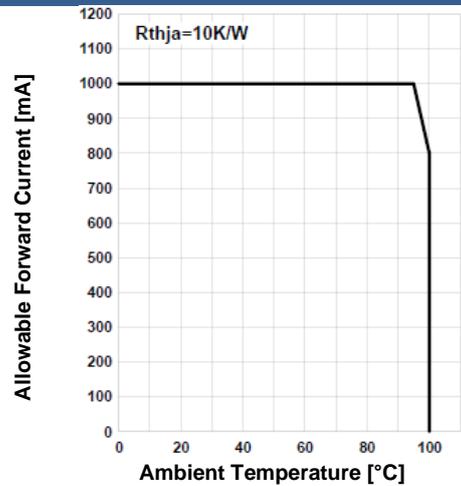
Forward Voltage vs. Ambient Temperature
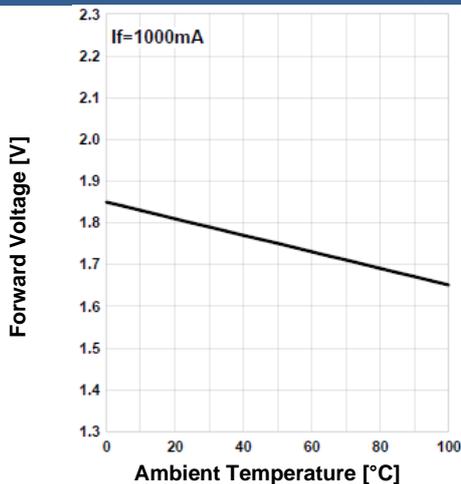
Rel. Radiant Intensity vs. Ambient Temperature

## Typical Performance Curves

Peak Wavelength vs. Amb. Temp.

If=1000mA

X-axis: Ambient Temperature [°C]
Y-axis: Peak Wavelength [nm]

Relative Spectral Emission

(ta=25°C)

X-axis: Wavelength [nm]
Y-axis: Relative Radiant Intensity [A.U.]

Radiation Characteristics

±65

X-axis: Angle [deg.]
Y-axis: Relative Radiant Intensity [A.U.]

Radiation Characteristics

±64

Angle (deg.)

Relative Radiant Intensity (A.U.)
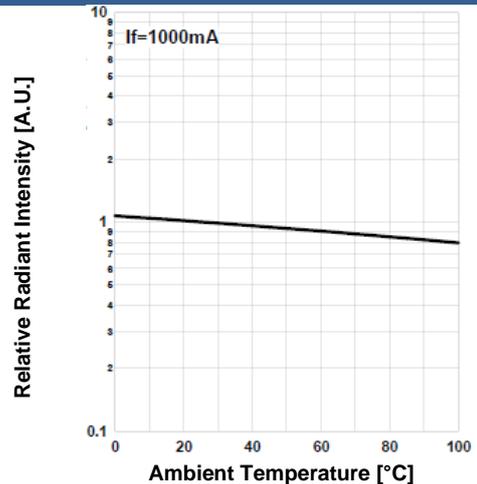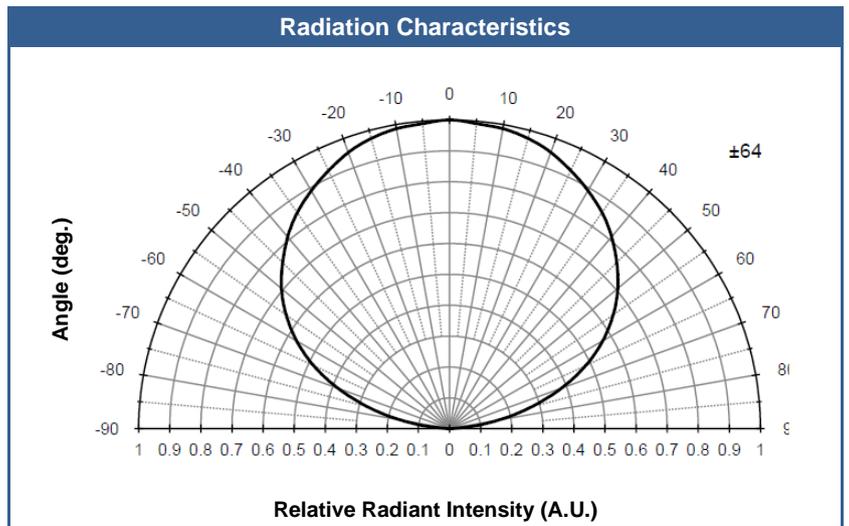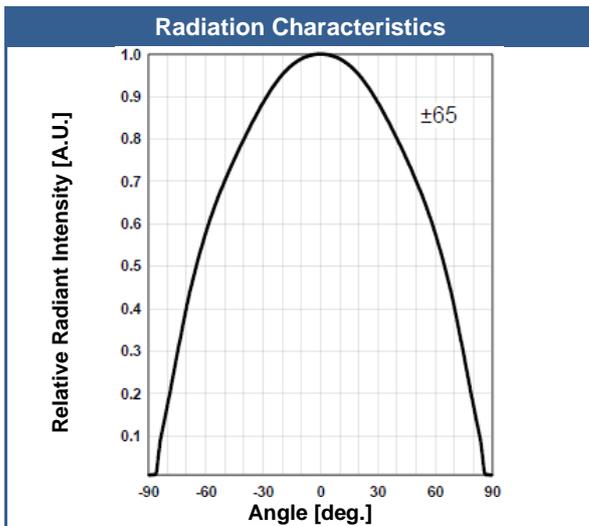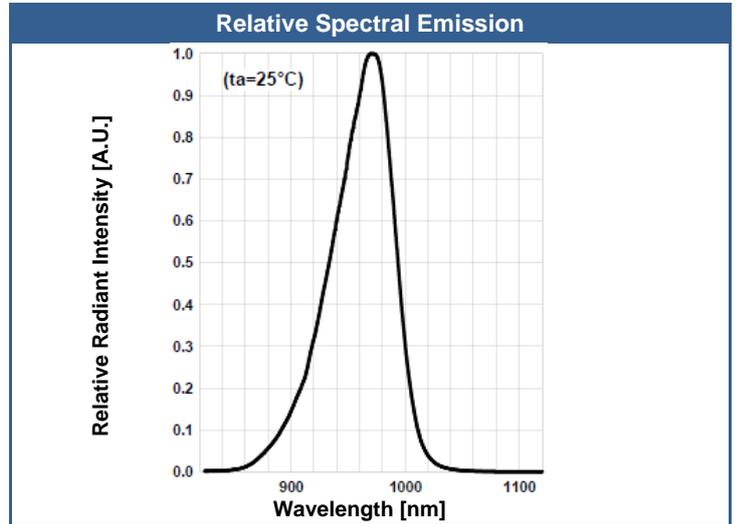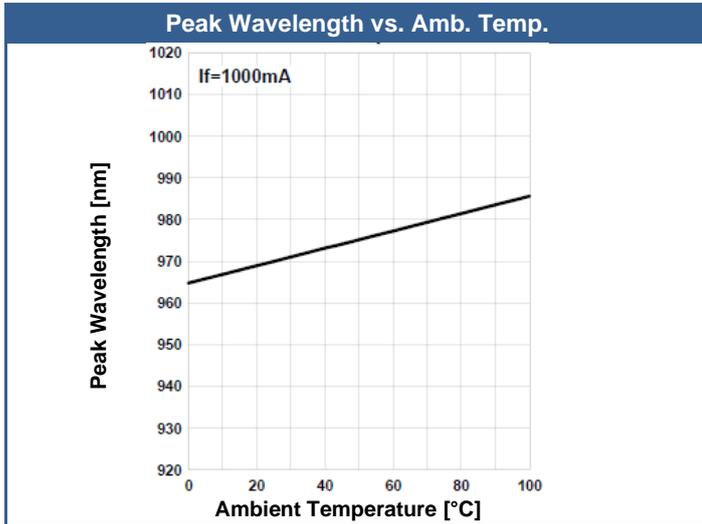
Outline Dimensions

PA9T

AnodeMark

anode

5

1

heatsink

cathode

5.2

4.6

4.2

2

3.6

5.2

a1

c1

heat sink
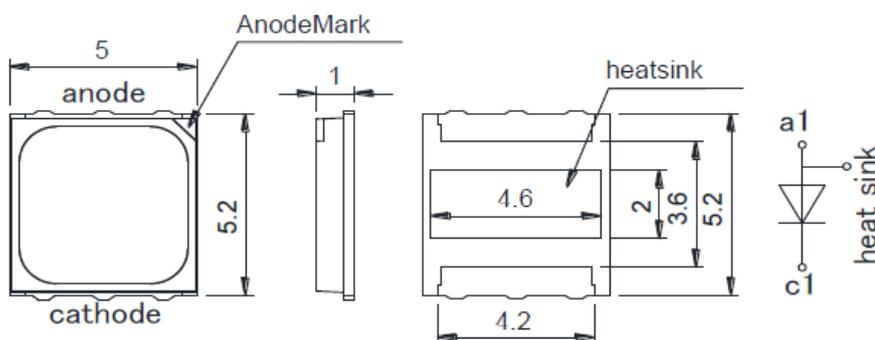
Lead	Function
Pin a1	Anode
Pin c1	Cathode

all dimensions in mm

General Notes

Soldering

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions	Recommended soldering patterns

Unit: mm
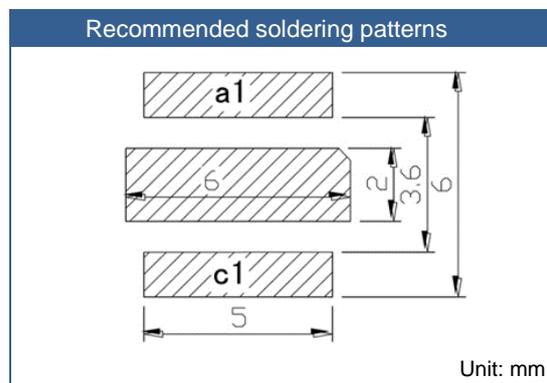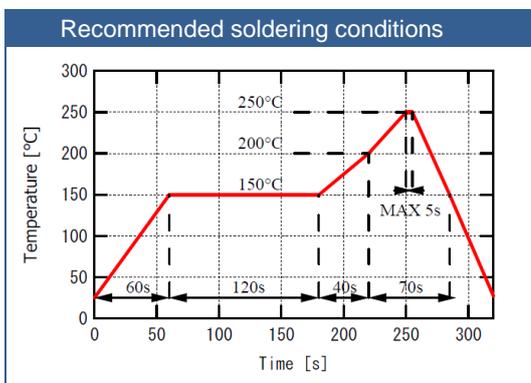
Cleaning

- **Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended**
- DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
- DO NOT USE ultrasonic cleaners

Static Electricity

- **LEDs are sensitive to electrostatic discharge (ESD)**.
- Precautions against ESD must be taken when handling or operating these LEDs
- Surge voltage or electrostatic discharge can result in complete failure of the LED.

Radiation

- During operation these LEDs do emit light, which **could be hazardous to skin and eyes**, and **may cause cancer**.
- Do avoid exposure to the emitted light. Protective glasses if needed
- It is further advised to attach a warning label on products/systems.

Operation

- **Do *only* operate LEDs with a current source.**
- Running these LEDs from a voltage source will result in complete failure of the device.
- Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

Storage

- The **maximum shelf life** of LEDs in the originally sealed aluminum bag is **12 months**.
- Before opening the aluminum bag, please store it at **<30 ºC, <60 % RH**.
- After opening the aluminum bag, please solder the LEDs within **72 hours (floor life)** at **5 – 30 ºC, <50 % RH**.
- Put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.